

**REMARKS**

**I. STATUS OF THE CLAIMS**

Claims 7-10 are canceled.

Various of the claim are amended herein.

New claims 13-16 are added.

Support for the claim amendments and new claims is found, for example, on page 8, last sentence, through page 9, first line; page 9, second paragraph from the bottom; page 10, second paragraph, through page 11, first paragraph, of the specification; and FIGS. 1-4.

Regarding new claims 13 and 16, see page 14, line 8 from the bottom, to page 15, line 3, of the specification.

In view of the above, it is respectfully submitted that claims 1-6 and 11-16 are currently pending.

**II. REJECTION OF CLAIMS 1 AND 2 UNDER 35 USC 102(E) AS BEING ANTICIPATED BY BRINDLE**

Claim 1 is amended to recite an upper plate for guiding and accommodating the electrical part.

Claim 1 is also amended to recite the contact sheet being disposed on an upper surface of the circuit board.

Further, claim 1 is amended to recite a lower plate disposed between the circuit board and the contact sheet for clamping end portions of the contact sheet and end portions of the land sheet between the upper and lower plates.

In addition, claim 1 is amended to recite the upper plate being provided with a side wall section extending downward for positioning the end portions of the contact sheet and the end portions of the land sheet.

Support for the amendments is found, for example, on page 8, last sentence, through page 9, first line; page 9, second paragraph from the bottom; page 10, second paragraph, through page 11, first paragraph, of the specification; and FIGS. 1-4.

It is respectfully submitted that Brindle does not disclose or suggest such features, or indicate any reason to provide such features.

The above comments are specifically directed to claim 1. However, it is respectfully submitted that the comments would be helpful in understanding various differences of various other claims over Brindle.

In view of the above, it is respectfully submitted that the rejection is overcome.

III. REJECTION OF CLAIMS 3-4 UNDER 35 USC 103 AS BEING UNPATENTABLE  
OVER BRINDLE IN VIEW OF SHIH

The above comments for distinguishing over Brindle also apply here, where appropriate.  
In view of the above, it is respectfully submitted that the rejection is overcome.

IV. REJECTION OF CLAIMS 5-6 UNDER 35 USC 103 AS BEING UNPATENTABLE  
OVER BRINDLE IN VIEW OF OKUNO

The above comments for distinguishing over Brindle also apply here, where appropriate.  
In view of the above, it is respectfully submitted that the rejection is overcome.

V. REJECTION OF CLAIMS 7-12 UNDER 35 USC 103 AS BEING  
UNPATENTABLE OVER BRINDLE IN VIEW OF IKEYA

The above comments for distinguishing over Brindle also apply here, where appropriate.  
In view of the above, it is respectfully submitted that the rejection is overcome.

VI. CONCLUSION

In view of the above, it is respectfully submitted that the application is in condition for  
allowance, and a Notice of Allowance is earnestly solicited.

If any further fees are required in connection with the filing of this response, please  
charge such fees to our Deposit Account No. 19-3935.

Respectfully submitted,

STAAS & HALSEY LLP

Date: October 14, 2004

By: 

Paul I. Kravetz  
Registration No. 35,230

1201 New York Avenue, NW, Suite 700  
Washington, D.C. 20005  
Telephone: (202) 434-1500  
Facsimile: (202) 434-1501